

Introduction

The Atmel® picoPower® ATmega644P is a low-power CMOS 8-bit microcontroller based on the AVR® enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATmega644P achieves throughputs close to 1MIPS per MHz. This empowers system designer to optimize the device for power consumption versus processing speed.

Feature

High Performance, Low Power Atmel® AVR® 8-Bit Microcontroller Family

- Advanced RISC Architecture
 - 131 Powerful Instructions
 - Most Single Clock Cycle Execution
 - 32 x 8 General Purpose Working Registers
 - Fully Static Operation
 - Up to 20 MIPS Throughput at 20MHz
 - On-chip 2-cycle Multiplier
- High Endurance Non-volatile Memory Segments
 - 64KBytes of In-System Self-Programmable Flash Program Memory
 - 2KBytes EEPROM
 - 4KBytes Internal SRAM
 - Write/Erase Cycles: 10,000 Flash/100,000 EEPROM
 - Data Retention: 20 Years at 85°C/100 Years at 25°C⁽¹⁾
 - Optional Boot Code Section with Independent Lock Bits
 - In-System Programming by On-chip Boot Program
 - True Read-While-Write Operation
 - Programming Lock for Software Security
- Atmel QTouch® Library Support
 - Capacitive Touch Buttons, Sliders and Wheels
 - QTouch and QMatrix acquisition

- Up to 64 Sense Channels
- JTAG (IEEE std. 1149.1 Compliant) Interface
 - Boundary-scan Capabilities According to the JTAG Standard
 - Extensive On-chip Debug Support
 - Programming of Flash, EEPROM, Fuses, and Lock Bits through the JTAG Interface
- Peripheral Features
 - Two 8-bit Timer/Counters with Separate Prescaler and Compare Mode
 - One 16-bit Timer/Counter with Separate Prescaler, Compare Mode, and Capture Mode
 - Real Time Counter with Separate Oscillator
 - Six PWM Channels
 - 8-channel 10-bit ADC
 - Differential Mode with Selectable Gain at 1×, 10× or 200×
 - One Byte-oriented 2-wire Serial Interface (Philips I²C compatible)
 - Two Programmable Serial USART
 - One Master/Slave SPI Serial Interface
 - Programmable Watchdog Timer with Separate On-chip Oscillator
 - On-chip Analog Comparator
 - Interrupt and Wake-up on Pin Change
- Special Microcontroller Features
 - Power-on Reset and Programmable Brown-out Detection
 - Internal Calibrated RC Oscillator
 - External and Internal Interrupt Sources
 - Six Sleep Modes: Idle, ADC Noise Reduction, Power-save, Power-down, Standby, and Extended Standby
- I/O and Packages
 - 32 Programmable I/O Lines
 - 40-pin PDIP
 - 44-lead TQFP
 - 44-pad VQFN/QFN
- Operating Voltage:
 - 1.8 - 5.5V for ATmega644PV
 - 2.7 - 5.5V for ATmega644P
- Speed Grades
 - ATmega644PV:
 - 0 - 4MHz @ 1.8V - 5.5V
 - 0 - 10MHz @ 2.7V - 5.5V
 - ATmega644P:
 - 0 - 10MHz @ 2.7V - 5.5V
 - 0 - 20MHz @ 4.5 - 5.5V
- Power Consumption at 1MHz, 1.8V, 25°C
 - Active Mode: 0.4mA
 - Power-down Mode: 0.1µA
 - Power-save Mode: 0.6µA (Including 32kHz RTC)

1. Refer to *Data Retention*.

Related Links

[Data Retention](#) on page 15

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1. Description

The Atmel® ATmega644P is a low-power CMOS 8-bit microcontroller based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATmega644P achieves throughputs close to 1MIPS per MHz. This empowers system designer to optimize the device for power consumption versus processing speed.

The Atmel AVR® core combines a rich instruction set with 32 general purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in a single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.

The ATmega644P provides the following features: 64Kbytes of In-System Programmable Flash with Read-While-Write capabilities, 2Kbytes EEPROM, 4Kbytes SRAM, 32 general purpose I/O lines, 32 general purpose working registers, Real Time Counter (RTC), three flexible Timer/Counters with compare modes and PWM, two serial programmable USARTs, one byte-oriented 2-wire Serial Interface (I2C), a 8-channel 10-bit ADC with optional differential input stage with programmable gain, a programmable Watchdog Timer with internal Oscillator, an SPI serial port, IEEE std. 1149.1 compliant JTAG test interface, also used for accessing the On-chip Debug system and programming and six software selectable power saving modes. The Idle mode stops the CPU while allowing the SRAM, Timer/Counters, SPI port, and interrupt system to continue functioning. The Power-down mode saves the register contents but freezes the Oscillator, disabling all other chip functions until the next interrupt or hardware reset. In Power-save mode, the asynchronous timer continues to run, allowing the user to maintain a timer base while the rest of the device is sleeping. The ADC Noise Reduction mode stops the CPU and all I/O modules except asynchronous timer and ADC to minimize switching noise during ADC conversions. In Standby mode, the crystal/resonator oscillator is running while the rest of the device is sleeping. This allows very fast start-up combined with low power consumption. In Extended Standby mode, both the main oscillator and the asynchronous timer continue to run.

Atmel offers the QTouch® library for embedding capacitive touch buttons, sliders and wheels functionality into AVR microcontrollers. The patented charge-transfer signal acquisition offers robust sensing and includes fully debounced reporting of touch keys and includes Adjacent Key Suppression® (AKS™) technology for unambiguous detection of key events. The easy-to-use QTouch Suite toolchain allows you to explore, develop and debug your own touch applications.

The device is manufactured using Atmel's high density non-volatile memory technology. The On-chip ISP Flash allows the program memory to be reprogrammed In-System through an SPI serial interface, by a conventional nonvolatile memory programmer, or by an On-chip Boot program running on the AVR core. The Boot program can use any interface to download the application program in the Application Flash memory. Software in the Boot Flash section will continue to run while the Application Flash section is updated, providing true Read-While-Write operation. By combining an 8-bit RISC CPU with In-System Self-Programmable Flash on a monolithic chip, the Atmel ATmega644P is a powerful microcontroller that provides a highly flexible and cost effective solution to many embedded control applications.

The ATmega644P is supported with a full suite of program and system development tools including: C Compilers, Macro Assemblers, Program Debugger/Simulators, In-Circuit Emulators, and Evaluation kits.

2. Configuration Summary

The table below compares the device series of feature and pin compatible devices, providing a seamless migration path.

Table 2-1. Configuration Summary and Device Comparison

| Features | ATmega164/V | ATmega324/V | ATmega644/V |
|---------------------------|--------------------------|--------------------------|--------------------------|
| Pin Count | 40/44 | 40/44 | 40/44 |
| Flash (Bytes) | 16K | 32K | 64K |
| SRAM (Bytes) | 1K | 2K | 4K |
| EEPROM (Bytes) | 512 | 1K | 2K |
| General Purpose I/O Lines | 32 | 32 | 32 |
| SPI | 1 | 1 | 1 |
| TWI (I ² C) | 1 | 1 | 1 |
| USART | 2 | 2 | 2 |
| ADC | 10-bit 15ksps | 10-bit 15ksps | 10-bit 15ksps |
| ADC Channels | 8 | 8 | 8 |
| Analog Comparator | 1 | 1 | 1 |
| 8-bit Timer/Counters | 2 | 2 | 2 |
| 16-bit Timer/Counters | 1 | 1 | 1 |
| PWM channels | 6 | 6 | 6 |
| Packages | PDIP TQFP VQFN/QFN | PDIP TQFP VQFN/QFN | PDIP TQFP VQFN/QFN |

3. Ordering Information

| Speed [MHz] ⁽³⁾ | Power Supply [V] | Ordering Code ⁽²⁾ | Package ⁽¹⁾ | Operational Range |
|----------------------------|------------------|----------------------------------|------------------------|--------------------------------|
| 10 | 1.8 - 5.5 | ATmega644PV-10AU | 44A | Industrial (-40°C to 85°C) |
| | | ATmega644PV-10AUR ⁽⁴⁾ | 44A | |
| | | ATmega644PV-10PU | 40P6 | |
| | | ATmega644PV-10MU | 44M1 | |
| | | ATmega644PV-10MUR ⁽⁴⁾ | 44M1 | |
| 20 | 2.7 - 5.5 | ATmega644P-20AU | 44A | Industrial (-40°C to 85°C) |
| | | ATmega644P-20AUR ⁽⁴⁾ | 44A | |
| | | ATmega644P-20PU | 40P6 | |
| | | ATmega644P-20MU | 44M1 | |
| | | ATmega644P-20MUR ⁽⁴⁾ | 44M1 | |
| 10 | 1.8 - 5.5 | ATmega644PV-10AN | 44A | Industrial (-40°C to 105°C) |
| | | ATmega644PV-10ANR ⁽⁴⁾ | 44A | |
| | | ATmega644PV-10PN | 40P6 | |
| | | ATmega644PV-10MN | 44M1 | |
| | | ATmega644PV-10MNR ⁽⁴⁾ | 44M1 | |
| 20 | 2.7 - 5.5 | ATmega644P-20AN | 44A | Industrial (-40°C to 105°C) |
| | | ATmega644P-20ANR ⁽⁴⁾ | 44A | |
| | | ATmega644P-20PN | 40P6 | |
| | | ATmega644P-20MN | 44M1 | |
| | | ATmega644P-20MNR ⁽⁴⁾ | 44M1 | |

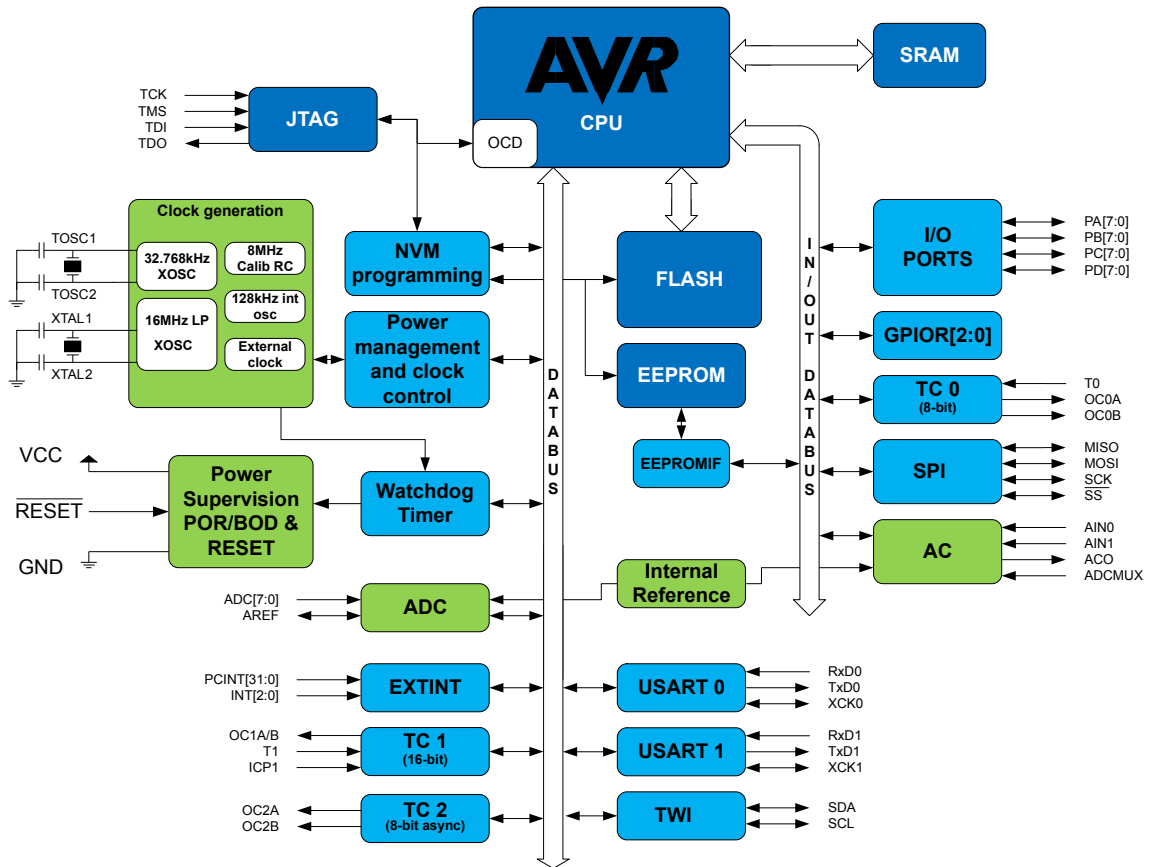
Note:

1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
3. Refer to *Speed Grades* for Speed vs. V_{CC}
4. Tape & Reel.

| Package Type | |
|--------------|--|
| 40P6 | 40-pin, 0.600" Wide, Plastic Dual Inline Package (PDIP) |
| 44A | 44-lead, Thin (1.0mm) Plastic Quad Flat Package (TQFP) |
| 44M1 | 44-pad, 7 × 7 × 1.0mm body, lead pitch 0.50mm, Thermally Enhanced Plastic Very Thin Quad Flat No-Lead (VQFN) |

4. Block Diagram









































Figure 4-1. Block Diagram



5. Pin Configurations

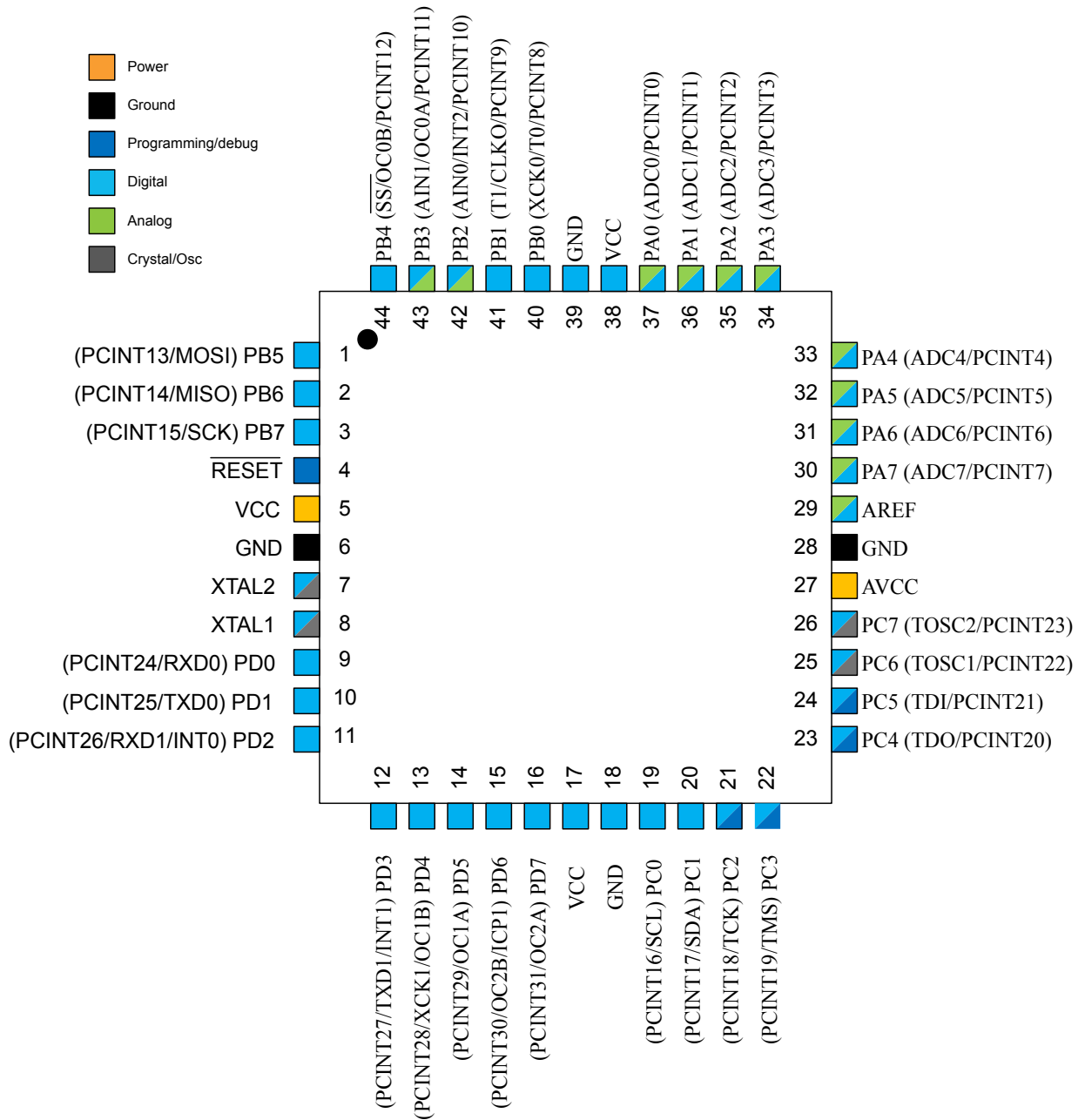
5.1. Pinout

5.1.1. PDIP

| | | | | | |
|--------------------------------------|---|----|----|---|---------------------|
| (PCINT8/XCK0/T0) PB0 |  | 1 | 40 |  | PA0 (ADC0/PCINT0) |
| (PCINT9/CLKO/T1) PB1 |  | 2 | 39 |  | PA1 (ADC1/PCINT1) |
| (PCINT10/INT2/AIN0) PB2 |  | 3 | 38 |  | PA2 (ADC2/PCINT2) |
| (PCINT11/OC0A/AIN1) PB3 |  | 4 | 37 |  | PA3 (ADC3/PCINT3) |
| (PCINT12/OC0B/ \overline{SS}) PB4 |  | 5 | 36 |  | PA4 (ADC4/PCINT4) |
| (PCINT13/MOSI) PB5 |  | 6 | 35 |  | PA5 (ADC5/PCINT5) |
| (PCINT14/MISO) PB6 |  | 7 | 34 |  | PA6 (ADC6/PCINT6) |
| (PCINT15//SCK) PB7 |  | 8 | 33 |  | PA7 (ADC7/PCINT7) |
| \overline{RESET} |  | 9 | 32 |  | AREF |
| VCC |  | 10 | 31 |  | GND |
| GND |  | 11 | 30 |  | AVCC |
| XTAL2 |  | 12 | 29 |  | PC7 (TOSC2/PCINT23) |
| XTAL1 |  | 13 | 28 |  | PC6 (TOSC1/PCINT22) |
| (PCINT24/RXD0) PD0 |  | 14 | 27 |  | PC5 (TDI/PCINT21) |
| (PCINT25/TXD0) PD1 |  | 15 | 26 |  | PC4 (TDO/PCINT20) |
| (PCINT26/RXD1/INT0) PD2 |  | 16 | 25 |  | PC3 (TMS/PCINT19) |
| (PCINT27/TXD1/INT1) PD3 |  | 17 | 24 |  | PC2 (TCK/PCINT18) |
| (PCINT28/XCK1/OC1B) PD4 |  | 18 | 23 |  | PC1 (SDA/PCINT17) |
| (PCINT29/OC1A) PD5 |  | 19 | 22 |  | PC0 (SCL/PCINT16) |
| (PCINT30/OC2B/ICP1) PD6 |  | 20 | 21 |  | PD7 (OC2A/PCINT31) |

| | |
|---|-------------------|
|  | Power |
|  | Ground |
|  | Programming/debug |
|  | Digital |
|  | Analog |
|  | Crystal/Osc |

5.1.2. TQFN and QFN



5.2. Pin Descriptions

5.2.1. VCC

Digital supply voltage.

5.2.2. GND

Ground.

5.2.3. Port A (PA[7:0])

This port serves as analog inputs to the Analog-to-digital Converter.

This is an 8-bit, bi-directional I/O port with internal pull-up resistors, individually selectable for each bit. The output buffers have symmetrical drive characteristics, with both high sink and source capability. As inputs, the port pins that are externally pulled low will source current if pull-up resistors are activated. Port pins are tri-stated when a reset condition becomes active, even if the clock is not running.

5.2.4. Port B (PB[7:0])

This is an 8-bit, bi-directional I/O port with internal pull-up resistors, individually selectable for each bit. The output buffers have symmetrical drive characteristics, with both high sink and source capability. As inputs, the port pins that are externally pulled low will source current if pull-up resistors are activated. Port pins are tri-stated when a reset condition becomes active, even if the clock is not running.

This port also serves the functions of various special features.

5.2.5. Port C (PC[7:0])

This is an 8-bit, bi-directional I/O port with internal pull-up resistors, individually selectable for each bit. The output buffers have symmetrical drive characteristics, with both high sink and source capability. As inputs, the port pins that are externally pulled low will source current if pull-up resistors are activated. Port pins are tri-stated when a reset condition becomes active, even if the clock is not running.

This port also serves the functions of the JTAG interface, along with special features.

5.2.6. Port D (PD[7:0])

This is an 8-bit, bi-directional I/O port with internal pull-up resistors, individually selectable for each bit. The output buffers have symmetrical drive characteristics, with both high sink and source capability. As inputs, the port pins that are externally pulled low will source current if pull-up resistors are activated. Port pins are tri-stated when a reset condition becomes active, even if the clock is not running.

This port also serves the functions of various special features.

5.2.7. $\overline{\text{RESET}}$

Reset input. A low level on this pin for longer than the minimum pulse length will generate a reset, even if the clock is not running. Shorter pulses are not guaranteed to generate a reset.

5.2.8. XTAL1

Input to the inverting Oscillator amplifier and input to the internal clock operating circuit.

5.2.9. XTAL2

Output from the inverting Oscillator amplifier.

5.2.10. AVCC

AVCC is the supply voltage pin for Port A and the Analog-to-digital Converter. It should be externally connected to V_{CC} , even if the ADC is not used. If the ADC is used, it should be connected to V_{CC} through a low-pass filter.

5.2.11. AREF

This is the analog reference pin for the Analog-to-digital Converter.

6. I/O Multiplexing

Each pin is by default controlled by the PORT as a general purpose I/O and alternatively it can be assigned to one of the peripheral functions.

The following table describes the peripheral signals multiplexed to the PORT I/O pins.

Table 6-1. PORT Function Multiplexing

| 32-pin TQFP/ QFN/ MLF Pin # | 40-pin PDIP Pin # | PAD | EXTINT | PCINT | ADC/AC | OSC | T/C # 0 | T/C # 1 | USART | I2C | SPI | JTAG |
|-----------------------------|-------------------|-------|--------|---------|--------|-------|---------|---------|-------|-----|-------|------|
| 1 | 6 | PB[5] | | PCINT13 | | | | | | | MOSI | |
| 2 | 7 | PB[6] | | PCINT14 | | | | | | | MISO | |
| 3 | 8 | PB[7] | | PCINT15 | | | | | | | SCK | |
| 4 | 9 | RESET | | | | | | | | | | |
| 5 | 10 | VCC | | | | | | | | | | |
| 6 | 11 | GND | | | | | | | | | | |
| 7 | 12 | XTAL2 | | | | | | | | | | |
| 8 | 13 | XTAL1 | | | | | | | | | | |
| 9 | 14 | PD[0] | | PCINT24 | | | | | RxD0 | | | |
| 10 | 15 | PD[1] | | PCINT25 | | | | | TxD0 | | | |
| 11 | 16 | PD[2] | INT0 | PCINT26 | | | | | RxD1 | | | |
| 12 | 17 | PD[3] | INT1 | PCINT27 | | | | | TXD1 | | | |
| 13 | 18 | PD[4] | | PCINT28 | | | | OC1B | XCK1 | | | |
| 14 | 19 | PD[5] | | PCINT29 | | | | OC1A | | | | |
| 15 | 20 | PD[6] | | PCINT30 | | | OC2B | ICP1 | | | | |
| 16 | 21 | PD[7] | | PCINT31 | | | OC2A | | | | | |
| 17 | - | VCC | | | | | | | RxD2 | | MISO1 | |
| 18 | - | GND | | | | | | | TxD2 | | MOSI1 | |
| 19 | 22 | PC[0] | | PCINT16 | | | | | | SCL | | |
| 20 | 23 | PC[1] | | PCINT17 | | | | | | SDA | | |
| 21 | 24 | PC[2] | | PCINT18 | | | | | | | | TCK |
| 22 | 25 | PC[3] | | PCINT19 | | | | | | | | TMS |
| 23 | 26 | PC[4] | | PCINT20 | | | | | | | | TDO |
| 24 | 27 | PC[5] | | PCINT21 | | | | | | | | TDI |
| 25 | 28 | PC[6] | | PCINT22 | | TOSC1 | | | | | | |
| 26 | 29 | PC[7] | | PCINT23 | | TOSC2 | | | | | | |
| 27 | 30 | AVCC | | | | | | | | | | |
| 28 | 31 | GND | | | | | | | | | | |
| 29 | 32 | AREF | | | AREF | | | | | | | |
| 30 | 33 | PA[7] | | PCINT7 | ADC7 | | | | | | | |
| 31 | 34 | PA[6] | | PCINT6 | ADC6 | | | | | | | |
| 32 | 35 | PA[5] | | PCINT5 | ADC5 | | | | | | | |
| 33 | 36 | PA[4] | | PCINT4 | ADC4 | | | | | | | |
| 34 | 37 | PA[3] | | PCINT3 | ADC3 | | | | | | | |

| 32-pin TQFP/ QFN/ MLF Pin # | 40-pin PDIP Pin # | PAD | EXTINT | PCINT | ADC/AC | OSC | T/C # 0 | T/C # 1 | USART | I2C | SPI | JTAG |
|-----------------------------|-------------------|-------|--------|---------|--------|------|---------|---------|-------|------|-----|------|
| 35 | 38 | PA[2] | | PCINT2 | ADC2 | | | | | | | |
| 36 | 39 | PA[1] | | PCINT1 | ADC1 | | | | | | | |
| 37 | 40 | PA[0] | | PCINT0 | ADC0 | | | | | | | |
| 38 | - | VCC | | | | | | | | SDA1 | | |
| 39 | - | GND | | | | | | | | SCL1 | | |
| 40 | 1 | PB[0] | | PCINT8 | | | T0 | | XCK0 | | | |
| 41 | 2 | PB[1] | | PCINT9 | | CLKO | | T1 | | | | |
| 42 | 3 | PB[2] | INT2 | PCINT10 | AIN0 | | | | | | | |
| 43 | 4 | PB[3] | | PCINT11 | AIN1 | | OC0A | | | | | |
| 44 | 5 | PB[4] | | PCINT12 | | | OC0B | | | | SS | |
| - | - | GND | | | | | | | | | | |
| - | - | GND | | | | | | | | | | |
| - | - | GND | | | | | | | | | | |
| - | - | GND | | | | | | | | | | |
| - | - | GND | | | | | | | | | | |

7. General Information

7.1. Resources

A comprehensive set of development tools, application notes, and datasheets are available for download on <http://www.atmel.com/avr>.

7.2. Data Retention

Reliability Qualification results show that the projected data retention failure rate is much less than 1 PPM over 20 years at 85°C or 100 years at 25°C.

7.3. About Code Examples

This documentation contains simple code examples that briefly show how to use various parts of the device. These code examples assume that the part specific header file is included before compilation. Be aware that not all C compiler vendors include bit definitions in the header files and interrupt handling in C is compiler dependent. Confirm with the C compiler documentation for more details.

For I/O Registers located in extended I/O map, “IN”, “OUT”, “SBIS”, “SBIC”, “CBI”, and “SBI” instructions must be replaced with instructions that allow access to extended I/O. Typically “LDS” and “STS” combined with “SBRS”, “SBRC”, “SBR”, and “CBR”.

7.4. Capacitive Touch Sensing

7.4.1. QTouch Library

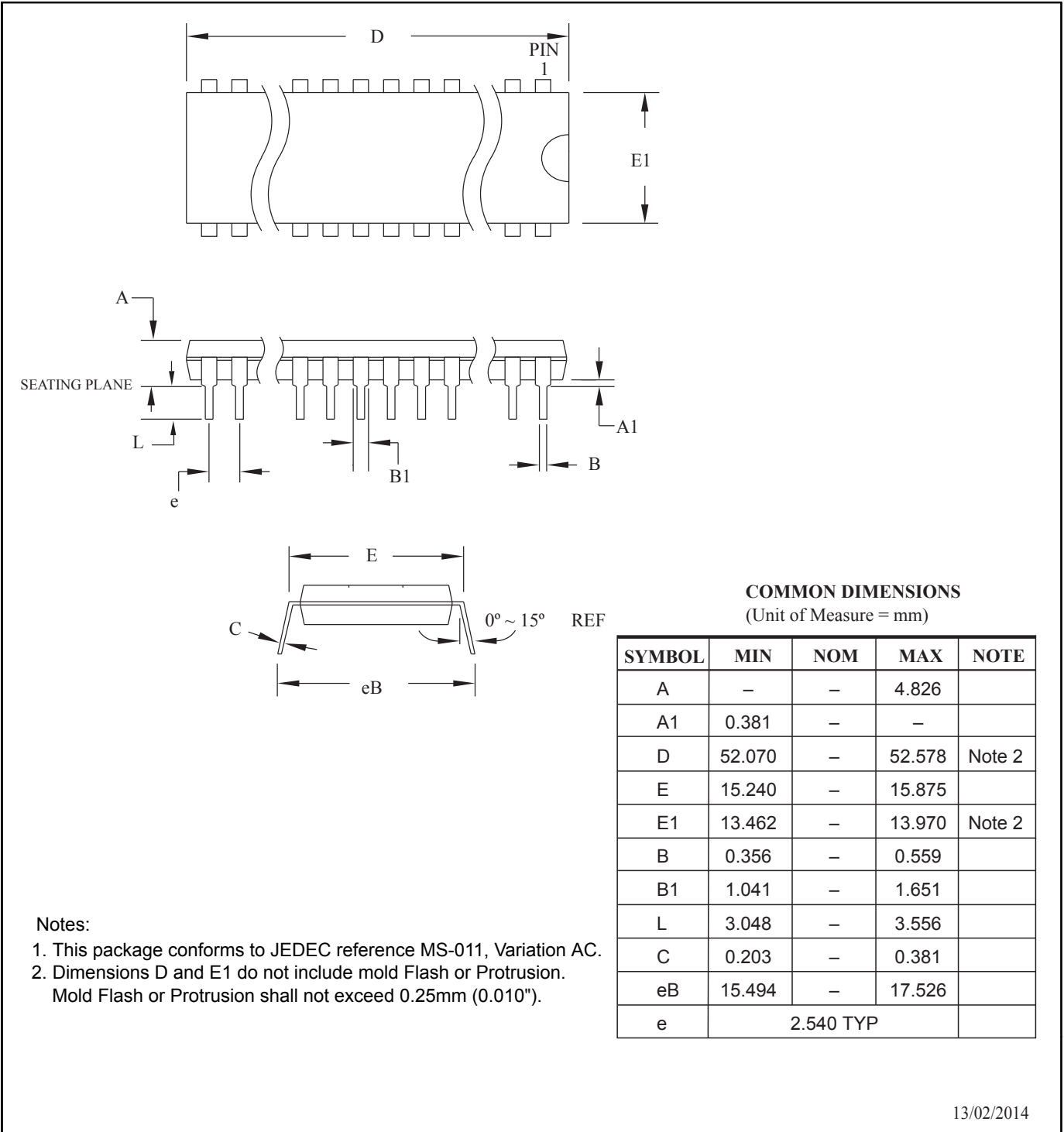
The Atmel® QTouch® Library provides a simple to use solution to realize touch sensitive interfaces on most Atmel AVR® microcontrollers. The QTouch Library includes support for the Atmel QTouch and Atmel QMatrix® acquisition methods.

Touch sensing can be added to any application by linking the appropriate Atmel QTouch Library for the AVR Microcontroller. This is done by using a simple set of APIs to define the touch channels and sensors, and then calling the touch sensing API's to retrieve the channel information and determine the touch sensor states.

The QTouch Library is FREE and downloadable from the Atmel website at the following location: <http://www.atmel.com/technologies/touch/>. For implementation details and other information, refer to the [Atmel QTouch Library User Guide](#) - also available for download from the Atmel website.

8. Packaging Information

8.1. 40-pin PDIP




COMMON DIMENSIONS
(Unit of Measure = mm)

| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|-----------|-----|--------|--------|
| A | – | – | 4.826 | |
| A1 | 0.381 | – | – | |
| D | 52.070 | – | 52.578 | Note 2 |
| E | 15.240 | – | 15.875 | |
| E1 | 13.462 | – | 13.970 | Note 2 |
| B | 0.356 | – | 0.559 | |
| B1 | 1.041 | – | 1.651 | |
| L | 3.048 | – | 3.556 | |
| C | 0.203 | – | 0.381 | |
| eB | 15.494 | – | 17.526 | |
| e | 2.540 TYP | | | |

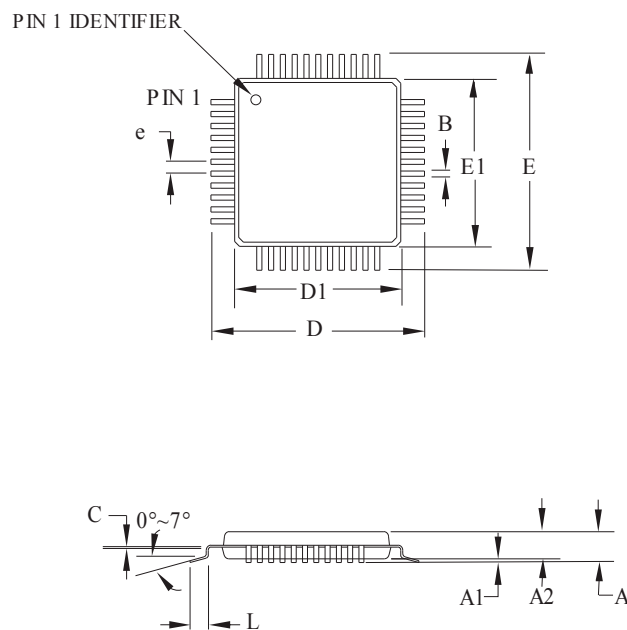
Notes:

1. This package conforms to JEDEC reference MS-011, Variation AC.
2. Dimensions D and E1 do not include mold Flash or Protrusion.
Mold Flash or Protrusion shall not exceed 0.25mm (0.010").

13/02/2014

| | | | |
|---|---|-------------|------|
|  Package Drawing Contact: packagedrawings@atmel.com | TITLE | DRAWING NO. | REV. |
| | 40P6 , 40-lead (0.600"/15.24mm Wide) Plastic Dual Inline Package (PDIP) | 40P6 | C |

8.2. 44-pin TQFP



COMMON DIMENSIONS
(Unit of Measure = mm)

| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|----------|--------|-------|--------|
| A | – | – | 1.20 | |
| A1 | 0.05 | – | 0.15 | |
| A2 | 0.95 | 1.00 | 1.05 | |
| D | 11.75 | 12.00 | 12.25 | |
| D1 | 9.90 | 10.00 | 10.10 | Note 2 |
| E | 11.75 | 12.00 | 12.25 | |
| E1 | 9.90 | 10.00 | 10.10 | Note 2 |
| B | 0.30 | 0.37 | 0.45 | |
| C | 0.09 | (0.17) | 0.20 | |
| L | 0.45 | 0.60 | 0.75 | |
| e | 0.80 TYP | | | |

Notes:

1. This package conforms to JEDEC reference MS-026, Variation ACB.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
3. Lead coplanarity is 0.10mm maximum.

06/02/2014

Atmel Package Drawing Contact:
packagedrawings@atmel.com

TITLE

44A, 44-lead, 10 x 10mm body size, 1.0mm body thickness,
0.8 mm lead pitch, thin profile plastic quad flat package (TQFP)

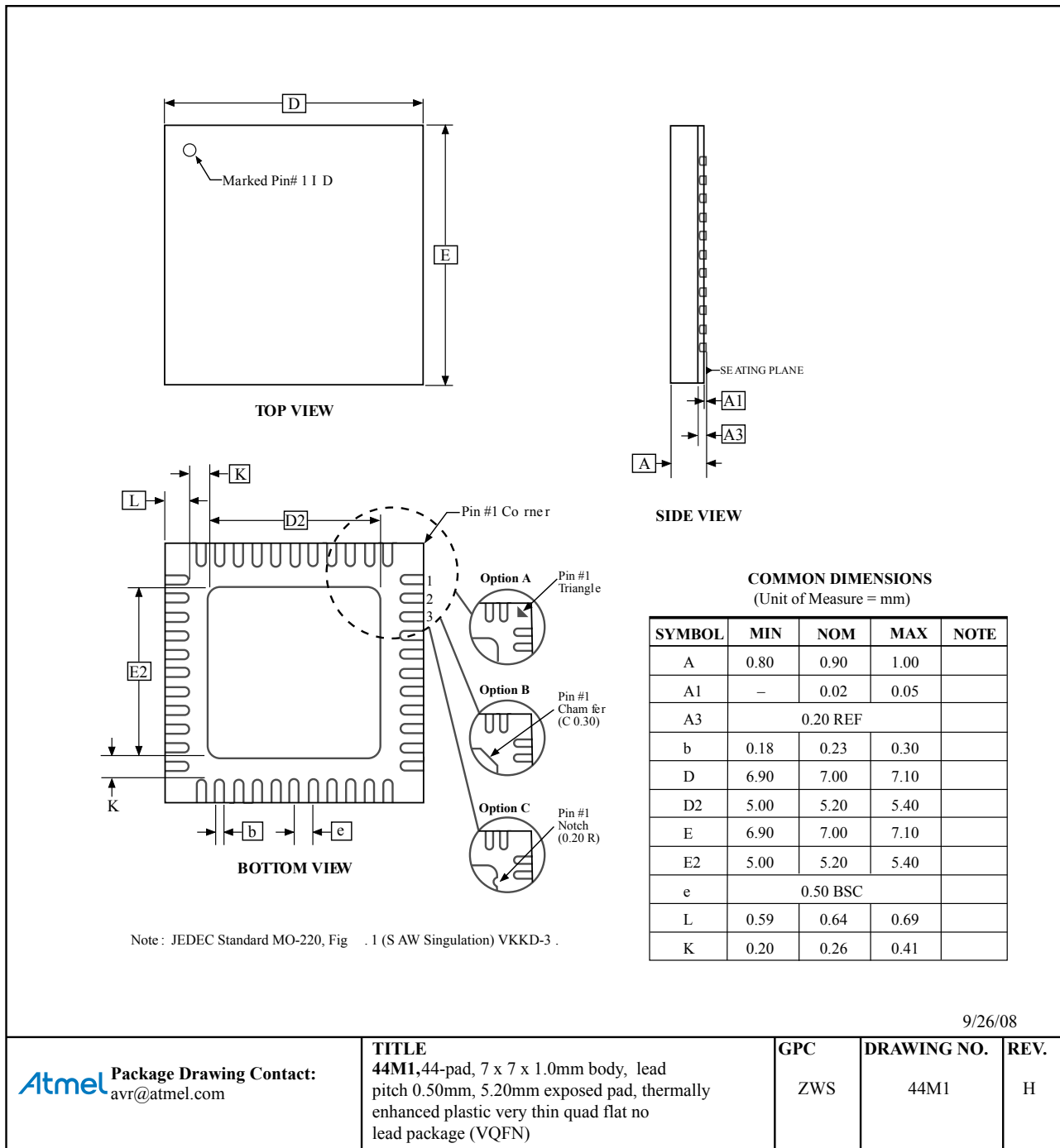
DRAWING NO.

44A

REV.

C

8.3. 44-pin VQFN



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